IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT(S) : Eliashevich et al.

FOR : OPTIMIZED CONTACT DESIGN FOR

THERMOSONIC BONDING OF FLIP-

CHIP DEVICES

SERIAL NO. : 10/588,473

FILED : August 1, 2006

EXAMINER : Jose R. Diaz

ART UNIT : 2815

CONFIRMATION NO. : 6709

ATTORNEY DOCKET NO. : GLOZ 200201

COMMENTS ON STATEMENT OF REASONS FOR ALLOWANCE

MAIL STOP AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

The Examiner indicated that claims 1-7 and 11-16 are allowed over the prior art. This recognition of allowable subject matter is acknowledged and appreciated.

However, while the applicant(s) agree(s) that the claims are allowable, the applicant(s) do not concede that the claims are only allowable for the precise reasons stated by the Examiner.

Furthermore, the applicant(s) do not concede that the Examiner's statements are entirely accurate and precise.

Respectfully submitted,

Name: Mary Ann Temesvari

	ray Sharpe LLP
6 Jun 2010	Robert M. Sieg
Date	Robert M. Sieg, Reg. No. 54,446
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CERTIFICATE OF MAILING OR TRANSMISSION	
I hereby certify that this correspondence (and any item referred to herein as being	
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Alexandria, VA 22313-1450 on th	e date indicated below.
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Express Mail Label No.:	Signature: Mary ann Terresvare
Date: Jan. 6, 2010	Name: Mary Ann Temesvari